

PALM INTRANET

Day: Tuesday Date: 7/27/2004

Time: 12:47:03

Inventor Name Search Result

Your Search was:

Last Name = WANG

First Name = TSUNG-HSIUNG

Application#	Patent#	Status	Date Filed	Title	Inventor Name 7
 10083366	Not Issued	060	02/27/2002	METHOD OF ENHANCEMENT OF ELECTRICAL CONDUCTIVITY FOR CONDUCTIVE POLYMER BY USE OF FIELD EFFECT CONTROL	WANG, TSUNG- HSIUNG
09312303	Not Issued	071		BUMPLESS FLIP CHIP PACKAGE AND METHOD FOR FABRICATING	WANG , TSUNG- HSIUNG
09312288	6204089	150		METHOD FOR FORMING FLIP CHIP PACKAGE UTILIZING CONE SHAPED BUMPS	WANG , TSUNG- HSIUNG
<u>09044969</u>	6119338	150	al O	METHOD FOR MANUFACTURING HIGH- DENSITY MULTILAYER PRINTED CIRCUIT BOARDS	WANG , TSUNG- HSIUNG
<u>07898008</u>	5268432	150		HEAT RESISTANT MODIFIED BISMALEIMIDE ADHESIVE COMPOSITION	WANG , TSUNG- HSIUNG
07821632	5342736	150			WANG , TSUNG- HSIUNG
07790260	5217599	150		BONDING OF POLYIMIDE FILM	WANG , TSUNG- HSIUNG

Inventor Search Completed: No Records to Display.

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Day: Tuesday Date: 7/27/2004

Time: 12:47:56

Inventor Name Search Result

Your Search was:

Last Name = PAN

First Name = JING-PIN

A	pplication#	Patent#	Status	Date Filed	Title	Inventor Name 22
	<u>10378603</u>	Not Issued	071		STRUCTURE OF AN INTERLEAVING STRIPED CAPACITOR SUBSTRATE	PAN, JING-PIN
	10162400	Not Issued	095	06/05/2002 N	COMPOSITION OF BARBITURIC ACID-MODIFIED BMI AND PPE CHAIN BROKEN IN PHENOL RESIN	PAN, JING-PIN
	10083366	Not Issued	060	02/27/2002	METHOD OF ENHANCEMENT OF ELECTRICAL CONDUCTIVITY FOR CONDUCTIVE POLYMER BY USE OF FIELD EFFECT CONTROL	PAN, JING-PIN
L		6562420	150	NO	LIQUID CRYSTAL ALIGNING FILM	PAN, JING-PIN
	098667 <u>27</u>	6432613	150		PHOTOSENSITIVE COMPOSITION	PAN, JING-PIN
	09628061	6359039	150	07/25/2000 /\/ U	MIXING BARBITURIC ACID- MODIFIED BMI WITH MEK SOLUTION OF EPOXY RESIN AND ELASTOMER	PAN, JING-PIN
	09292873	<u>6166322</u>	150	ND	ENCAPULATION FOR MONO- AND POLYCRYSTALLINE SILICON SOLAR CELL MODULES	PAN , JING-PIN
	09253836	611795 <u>1</u>	150		POLYIMIDE COMPOSITION FOR LOC ADHESIVE TAPE	PAN , JING-PIN
	09240797	63405 <u>16</u>	150		INK JET RECORDING MATERIALS	PAN , JING-PIN
9	09067972	Not Issued	161		HIGH-PERFORMANCE ADHESIVE COMPOSITIONS	PAN , JING-PIN
9	<u>.</u>	5928789	150	12/29/1997 ບ [ຸ] ນ	INK JET PRINTING MEDIUM	PAN , JING-PIN

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<u>\$68907570</u>	Not Issued	163/	08/08/1997	ENCAPULATION PROCESS FOR MONO- AND POLYCRYSTALLINE SILICON SOLAR CELL MODULES	PAN , JING-PIN
20202570	5510770	150	00/00/1004		
	5518779			FORMING COPPER CLAD LAMINATES	PAN , JING-PIN
08198352	5418066	250	, ,	POLYIMIDE COMPOSITION FOR POLYIMIDE/COPPER FOIL LAMINATE	PAN , JING-PIN
08089797	5602213	150	.10	HEAT RESISTANT COMPOSITION BISMALEIMIDE-MODIFIED POLYURETHANE	PAN , JING-PIN
08070537	5290909	150	4.05	POLYIMIDE COMPOSITION FOR POLYIMIDE/COPPER FOIL LAMINATE	PAN , JING-PIN
07991287	5372891	150	12/16/1992 NU	A FLEXIBLE COPPER/POLYIMIDE AND BARBITURIC ACID MODIFIED BISMALEIMIDE BLEND/ POLYIMIDE LAMINATE	PAN , JING-PIN
07966738	5310850	250	ļ	HEAT RESISTANT POLY (URETHANE AMIDEIMIDE) COMPOSITION AND METHOD FOR PREPARING THE SAME	PAN , JING-PIN
07911692	5326794	150	(m)	BARBITURIC ACID-MODIFIED BISMALEIMIDE WITH DIAMINE AND POLYISOCYANATE- MODIFIED EPOXY RESIN	PAN , JING-PIN
07898008	<u>5268432</u>	150		HEAT RESISTANT MODIFIED BISMALEIMIDE ADHESIVE COMPOSITION	PAN , JING-PIN
07827591	5225250	150	l	METHOD OF IMPREGNATING USING A FLOATING BLADE	PAN , JING-PIN
07281069	5041519	150	12/08/1988	COMPOSITION COMPRISING EPOXY RESIN, BISMALEIMIDE AND BARBITURIC ACID	PAN , JING-PIN

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	L #	Hits	Search Text	DBs	Time Stamp
	T.C		(427/488-491,535-539, 575).CCLS.	USPA T; US-P GPUB ; EPO;	2004/06/0
1	L 6	2780		JPO; DERW ENT; IBM_ TDB	1 09:21
2	L 7	13648 6	(conductive adj (polymer plastic monomer dimer oligmer) polyaniline polypyrrole polythiophene aniline pyrrole thiophene)	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM_ TDB	2004/06/0 1 09:22
3	L8 .	82	6 and 7	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/06/0 1 09:22
4	L9	24	8 and (plasma same microwave)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/06/0 1 09:23

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	L #	Hits	Search Text	DBs	Time Stamp
5	L10	115	(plasma same microwave) and(conductive adj (polymer plastic monomer dimer oligmer) polyaniline polypyrrole polythiophene)not 9	USPA T; US-P GPUB; IPO; DERW ENT; IBM_ TDB	2004/06/0 1 09:24

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